

## LBSS123LT1G

Rev-1.1

SuperMOS – SOT-23 100V  $BV_{DSS}$ ,  $2.70\Omega$   $R_{DS(ON)}$ , N-channel MOSFET

## 1. Description

The LBSS123LT1G is N-Channel enhancement MOS Field Effect Transistor. Uses advanced technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. Device is suitable for use in DC-DC conversion, power switch and charging circuit. Standard Product LBSS123LT1G is Pb-free.

## 2. Features

- 100V,  $R_{DS(ON)}=2.70\Omega$ (Typ.) @  $V_{GS}=10V$   
 $R_{DS(ON)}=2.95\Omega$ (Typ.) @  $V_{GS}=4.5V$
- High density cell design for low  $R_{DS(on)}$
- Material: Halogen free
- Reliable and rugged
- Avalanche Rated
- Low leakage current

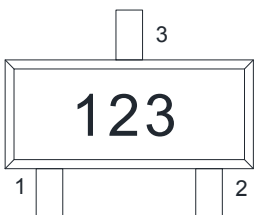
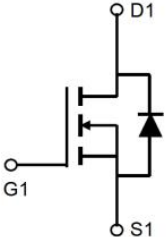
## 3. Applications

- PWM applications
- Load switch
- Power management in portable/desktop PCs
- DC/DC conversion

## 4. Ordering Information

Part Number	Package	Marking	Material	Packing	Quantity per reel	Flammability Rating	Reel Size
LBSS123LT1G	SOT-23	123	Halogen free	Tape & Reel	3,000 PCS	UL 94V-0	7 inches

## 5. Pin Configuration and Functions

Pin	Function	Outline	Circuit Diagram
1	Gate		
2	Source		
3	Drain		

## 6. Specification

### Absolute Maximum Rating & Thermal Characteristics

Ratings at 25 °C ambient temperature unless otherwise specified.

Parameter		Symbol	Limit	Unit
Drain-Source Voltage		$BV_{DSS}$	100	V
Gate-Source Voltage		$V_{GS}$	±20	V
Continuous Drain Current	$T_A=25^{\circ}\text{C}$	$I_D$	0.29	A
	$T_A=70^{\circ}\text{C}$		0.20	
Maximum Power Dissipation		$P_D$	0.35	W
Operating Junction Temperature		$T_J$	150	°C
Lead Temperature		$T_L$	260	°C
Storage Temperature Range		$T_{stg}$	-55 to 150	°C

### Thermal resistance ratings

Single Operation					
Parameter		Symbol	Typical	Maximum	Unit
Junction-to-Ambient Thermal Resistance	$t \leq 10\text{s}$	$R_{\theta JA}$		357	°C/W

## Electrical Characteristics

At TA = 25°C unless otherwise specified

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
OFF CHARACTERISTICS						
Drain-to-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250uA	100			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =100V, V <sub>GS</sub> =0V			100	nA
Gate-to-source Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> =0V, V <sub>GS</sub> =±20V			±100	nA
ON CHARACTERISTICS						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA	1.0	1.8	2.5	V
Drain-to-source On-resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =0.2A		2.7	3.5	Ω
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =0.18A		2.95	4.2	
CHARGES, CAPACITANCES AND GATE RESISTANCE						
Input Capacitance	C <sub>ISS</sub>	V <sub>GS</sub> =0V, f=1MHz, V <sub>DS</sub> =25V		29		pF
Output Capacitance	C <sub>OSS</sub>			2.8		
Reverse Transfer Capacitance	C <sub>RSS</sub>			2.0		
Gate Resistance	R <sub>g</sub>	f=1MHz		1.3		Ω
BODY DIODE CHARACTERISTICS						
Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =0.2A	0.45		1.5	V

7. Typical Characteristic

Figure 1: Output Characteristics

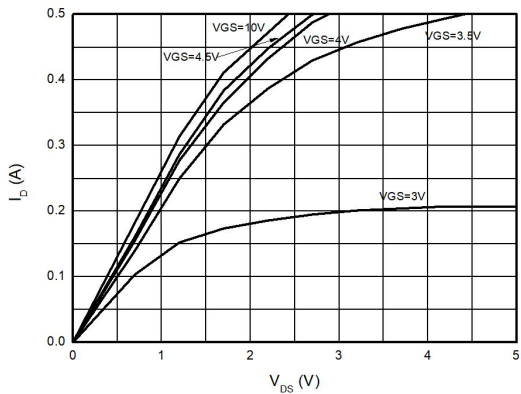


Figure 2: Transfer Characteristics

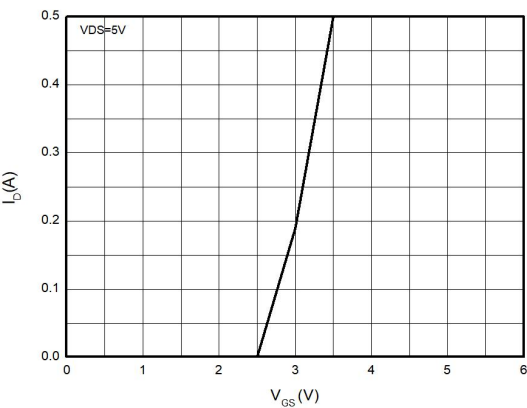


Figure 3: On-resistance vs Drain Current

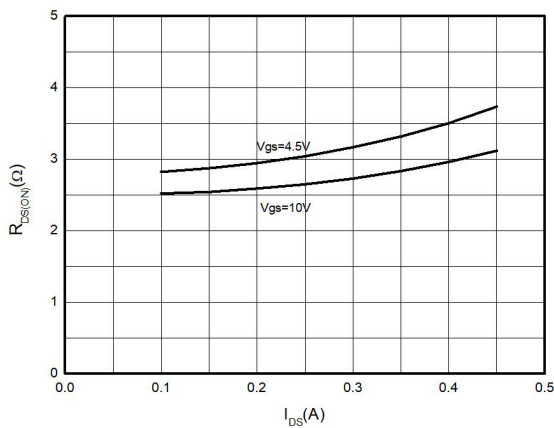


Figure 4: Body Diode Characteristics

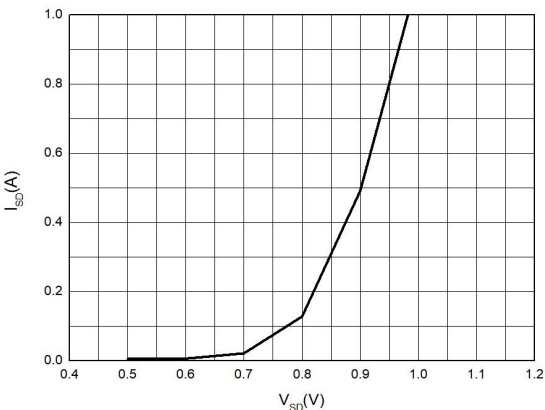


Figure 5: Capacitance Characteristics

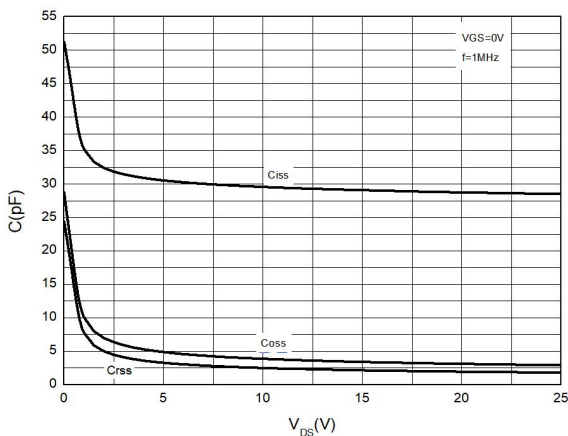
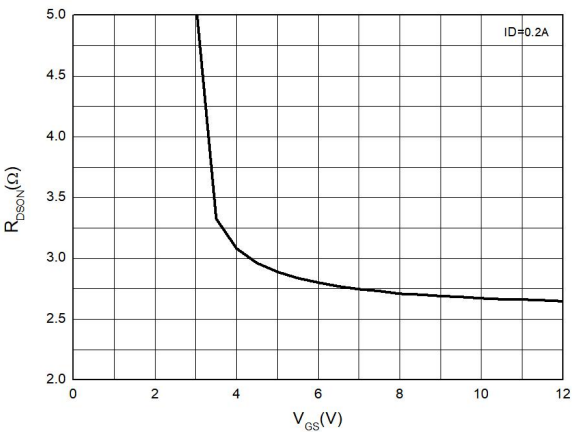
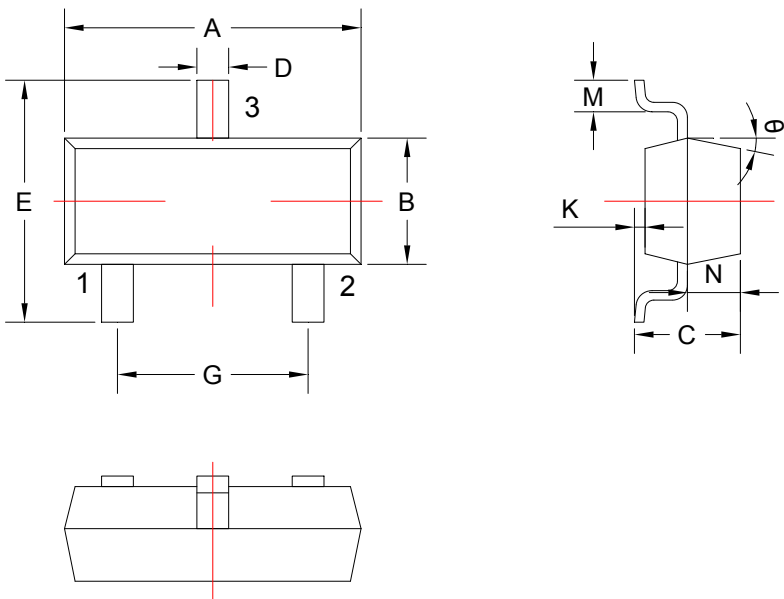


Figure 6: On-resistance vs Gate to Source



8. Dimension (SOT-23)



COMMON DIMENSIONS CUNITS MEASURE=MILLIMETER					
SYMBOL	MIN	MAX	SYMBOL	MIN	MAX
A	2.85	3.04	G	1.80	2.00
B	1.20	1.40	K	0	0.10
C	0.90	1.10	M	0.20	-
D	0.40	0.50	N	0.50	0.70
E	2.25	2.55	$\theta$	5°	9°

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